Technical Data :

N 4 9 0 S H 2 6

- Power Thyristor

2600 V_{DRM};

HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

Features:

- . All Diffused Structure
- . Center Amplifying Gate Configuration
- . Blocking capabilty up to 2600 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device

ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

| Device Type | V _{RRM} (1) | V _{DRM} (1) | V _{RSM} (1) |
|-------------|----------------------|----------------------|----------------------|
| N490SH26 | 2600 | 2600 | 2700 |

 V_{RRM} = Repetitive peak reverse voltage

 V_{DRM} = Repetitive peak off state voltage

 V_{RSM} = Non repetitive peak reverse voltage (2)

| Repetitive peak reverse leakage and off state leakage | $I_{RRM/}I_{DRM}$ | 100 mA (3) |
|---|-------------------|-------------|
| Critical rate of voltage rise | dV/dt (4) | 1000 V/µsec |

Notes:

All ratings are specified for Tj=25 °C unless otherwise stated.

- All voltage ratings are specified for an applied 50Hz/60zHz sinusoidal waveform over the temperature range -40 to +125 °C.
- (2) 10 msec. max. pulse width
- (3) Maximum value for Tj = 125 °C.
- (4) Minimum value for linear and exponential waveshape to 80% rated V_{DRM} . Gate open. Tj = 125 °C.
- (5) Non-repetitive value.
- (6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a $0.2 \ \mu$ F capacitor and 20 ohms resistance in parallel with the thristor under test.

Conducting - on state

| Parameter | Symbol | Min. | Max. | Тур. | Units | Conditions |
|---|--------------------|------|---------------------|------|------------------|--|
| Average value of on-state current | I _{T(AV)} | | 997 | | А | Sinewave, 180° conduction, $T_{sh} = 85^{\circ}C$ |
| Average value of on-state current | I _{T(AV)} | | 1467 | | А | Sinewave,180° conduction,T _{sh} =55°C |
| Peak one cPSTCle surge (non repetitive) current | I _{TSM} | | 21500 | | A A | 10.0 msec (50Hz), sinusoidal wave- shape, 180° conduction, $T_j = 125 {}^{\circ}C$ |
| I square t | I ² t | | 2.3×10^{6} | | A ² s | 10.0 msec |
| Latching current | IL | | 800 | | mA | $V_D = 24 V; R_L = 12 ohms$ |
| Holding current | I _H | | 400 | | mA | $V_{D=} 24 \text{ V}; I = 2.5 \text{ A}$ |
| Peak on-state voltage | V _{TM} | | 1.75 | | V | $I_{TM} = 2550 \text{ A}; \text{ Duty cPSTCle} \le 0.01\%$ $T_i = 125 \text{ °C}$ |
| Critical rate of rise of on-state current (5, 6) | di/dt | | 200 | | A/µs | Switching from $V_{DRM} \le 1000 \text{ V}$, non-repetitive |
| Critical rate of rise of on-state current (6) | di/dt | | 100 | | A/µs | Switching from $V_{DRM} \le 1000 V$ |

Page 1 of 3

Technical Data :

ELECTRICAL CHARACTERISTICS AND RATINGS Thyristor

Gating

| Parameter | Symbol | Min. | Max. | Тур. | Units | Conditions |
|--|--------------------|------|-------------------|------|----------------|---|
| Peak gate power dissipation | P _{GM} | | 200 | | W | $t_p = 40 \text{ us}$ |
| Average gate power dissipation | P _{G(AV)} | | 5 | | W | |
| Peak gate current | I _{GM} | | 10 | | Α | |
| Gate current required to trigger all units | I _{GT} | | 300 200 125 | | mA mA mA | $V_D = 12 \text{ V}; R_L = 3 \text{ ohms}; T_j = -40 \text{ °C}$ $V_D = 12 \text{ V}; R_L = 3 \text{ ohms}; T_j = +25 \text{ °C}$ $V_D = 12 \text{ V}; R_L = 3 \text{ ohms}; T_j = +125 \text{ °C}$ |
| Gate voltage required to trigger all units | V _{GT} | 0.30 | 53 | | V V V | $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = -40 \text{ °C}$ $V_D = 6 V; R_L = 3 \text{ ohms}; T_j = 0.125 \text{ °C}$ $V_D = \text{Rated } V_{DRM}; R_L = 1000 \text{ ohms};$ $T_j = + 125 \text{ °C}$ |
| Peak negative voltage | V _{GRM} | | 5 | | V | |

Dynamic

| Parameter | Symbol | Min. | Max. | Тур. | Units | Conditions |
|---|-----------------|------|------|------|-------|--|
| Delay time | t _d | | 1.5 | 0.7 | μs | $I_{TM} = 50 \text{ A}; V_D = \text{Rated } V_{DRM}$ Gate pulse: $V_G = 20 \text{ V}; R_G = 20 \text{ ohms};$ $t_r = 0.1 \mu\text{s}; t_p = 20 \mu\text{s}$ |
| Turn-off time (with $V_R = -50 \text{ V}$) | t _q | | 250 | 100 | μs | $I_{TM} = 1000 \text{ A}; \text{ di/dt} = 25 \text{ A/}\mu\text{s};$ $V_R \ge -50 \text{ V}; \text{ Re-applied } \text{dV/dt} = 20$ $V/\mu\text{s linear to } 80\% \text{ V}_{DRM}; \text{ V}_G = 0;$ $T_i = 125 ^\circ\text{C}; \text{ Duty cPSTCle} \ge 0.01\%$ |
| Reverse recovery charge | Q _{rr} | | * | | μC | $I_{TM} = 1000 \text{ A}; \text{ di/dt} = 25 \text{ A/}\mu\text{s};$ $V_R \ge -50 \text{ V}$ |

* For guaranteed max. value, contact factory.

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

| Parameter | Symbol | Min. | Max. | Тур. | Units | Conditions |
|---------------------------------------|----------------------|------|----------------|------|-------|--|
| Operating temperature | Tj | -40 | +125 | | °C | |
| Storage temperature | T _{stg} | -40 | +150 | | °C | |
| Thermal resistance - junction to case | R _e (j-c) | | 0.025 0.050 | | °C/W | Double sided cooled Single sided cooled |
| Thermal resistance - case to sink | R _e (c-s) | | 0.010 0.020 | | °C/W | Double sided cooled * Single sided cooled * |
| Mounting force | Р | 19.5 | 26.7 | | kN | |
| Weight | W | | | 510 | g | |

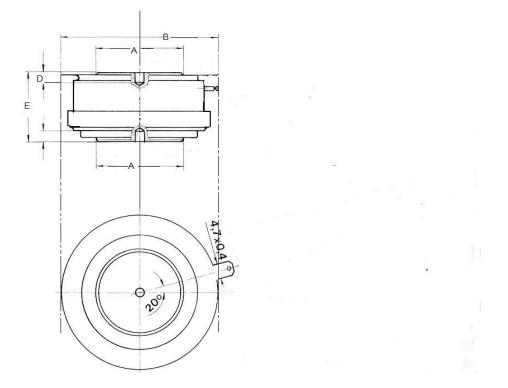
* Mounting surfaces smooth, flat and greased

Note : for case outline and dimensions, see case outline drawing in page 4 of this Technical Data

Technical Data :

N490SH26 - Power

CASE OUTLINE AND DIMENSIONS. Thyristor



| Sym | А | В | Е |
|--------|------|------|--------|
| Inches | 1.85 | 2.91 | 1.02 |
| mm | 47 | 74 | 26±1.0 |